

## ( V ) Preliminary Specifications( ) Final Specifications

Module	13.3"(13.26") FHD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B133HAK01.0 (HW:0A)
Note ( 🗭 )	oTP Display

Customer	Date
Checked & Approved by	Date
Note: This Specification is without notice.	s subject to change

Approved by	Date			
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Prepared by	Date			
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AU Optronics corporation				



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## **Record of Revision**

Ve	Version and Date Page		Old description	New Description	Remark
0.1	2016/03/30	All	First Edition for Customer		



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### 1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 10) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 11)Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 12) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.



### 2. General Description

B133HAK01.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 FHD, 1920(H) x1080(V) screen and 262K colors (RGB –6bits with FRC)with LED backlight driving circuit. All input signals are eDP (Embedded DisplayPort) interface compatible.

B133HAK01.0 is designed for a display unit of notebook style personal computer and industrial machine.

### 2.1 General Specification

The following items are characteristics summary on the table at 25  $^{\circ}\mathrm{C}$  condition:

Items	Unit	Specifications					
Screen Diagonal	[mm]	336.71	336.71				
Active Area	[mm]	293.472x1	65.078				
Pixels H x V		1920x3(RG	3B) x 108	0			
Pixel Pitch	[mm]	0.1529 x 0	.1529				
Pixel Format		R.G.B. Ver	tical Strip	е			
Display Mode		Normally B	lack				
White Luminance (ILED=24mA) (Note: ILED is LED current)	[cd/m <sup>2</sup> ]	300 typ. (5 points average) 255 min. (5 points average)					
Luminance Uniformity		1.25 max.	(5 points)				
Contrast Ratio		800 typ					
Response Time	[ms]	27 typ / 35	Max				
Nominal Input Voltage VDD	[Volt]	+3.3 typ.					
Power Consumption	[Watt]	4.6 max (Ir	nclude Lo	gic and E	Blu power)		
Weight	[Grams]	235 max (Total Solution) <sup>1</sup>					
		Min. Typ. Max.					
Physical Size		Length	304.85	305.35	305.85		
Include bracket	[mm]	Width	193.21	193.71	194.21		
		Thickness	-	-	2.75 (Panel Side) 3.2 (PCBA Side)		

<sup>&</sup>lt;sup>1</sup> Total solution max weight includes touch sensor FPCA and OGS.



Electrical Interface		2 Lane eDP 1.2
Glass Thickness	[mm]	0.3
Surface Treatment		Anti Glare
Support Color		262K colors ( RGB 6-bit )
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance



## 2.2 General Touch Specification

Item	Spec	Unit
Type of Touch Sensor	Projective Capacitive (On cell)	
Panel Size	13.3"	
Outline Dimension	NA	mm
Total Thickness	NA	mm
Total Weight	NA	g
TP View Area	294.472 X 166.078 typ	mm
TP Active Area	295.872 X 167.478 typ	mm
Interface	USB	
Report Rate	Follow win10 - ≥100Hz	Hz
Multi-Touch Point	10 points	
Input method	Finger	
Touch panel sensor IC	Raydium (RM32380)	
Channel	70 x 40	
Distance between 2 point	Follow win10	mm
Surface hardness	<b>3</b> (Note 1)	Н
Surface treatment	NA	
TP F/W version	TBD (Version : 00)	
Support OS	Window 10	
BM ink	NA	
TP Power Consumption	Active Mode: 300	mW



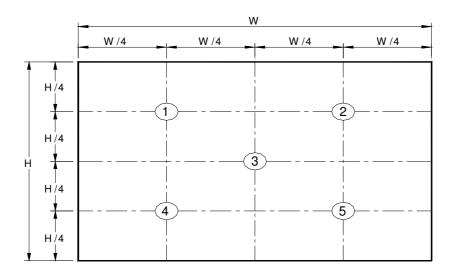
### 2.3 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature) :

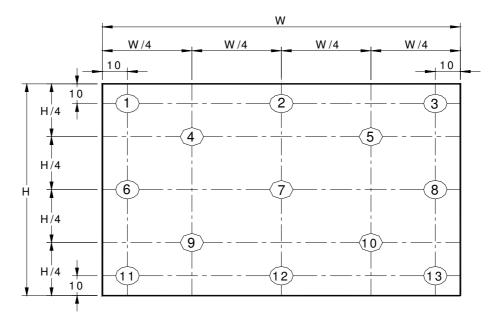
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Note
White Lumir ILED=23r (Base Panel	nΑ		5 points average	255	300	-	cd/m2	1, 4, 5.
Viewing A	ngle	θR θL	Horizontal (Right) CR = 10 (Left)	80 80	85 85	-	degree	4, 9
		ψH ψL	Vertical (Upper) CR = 10 (Lower)	80 80	85 85	-		
Luminan Uniformi		δ5Р	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ13Ρ	13 Points	-	-	1.6		2, 3, 4
Contrast R	atio	CR		700	800	-		4, 6
Cross ta	lk	%				4		4, 7
Response <sup>-</sup>	Time	TRT	Rising + Falling	-	27	35		
	Red	Rx		0.609	0.639	0.669		
		Ry		0.307	0.337	0.367		
Color /	Green	Gx		0.289	0.319	0.349		
Chromaticity		Gy		0.576	0.606	0.636	_	
Coodinates	Blue	Вх	CIE 1931	0.121	0.151	0.181	-	4
Coodinates	Diue	Ву		0.011	0.041	0.071	-	
	\A/I ·-	Wx		0.283	0.313	0.343	-	
	White	Wy		0.299	0.329	0.359		
NTSC		%		-	72	-		



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

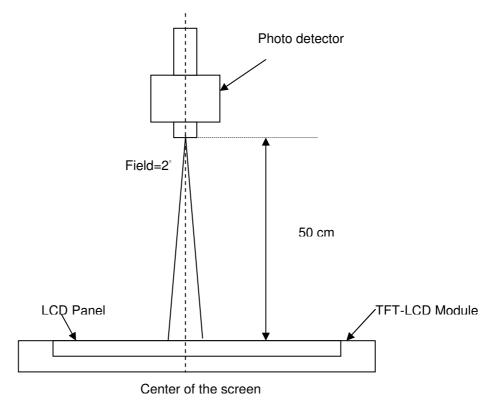
2 _	_	Maximum Brightness of five points
δ w5	= -	Minimum Brightness of five points
2	_	Maximum Brightness of thirteen points
$\delta_{W13} =$	Minimum Brightness of thirteen points	

### Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



**Note 5**: Definition of Average Luminance of White (Y<sub>L</sub>):

Measure the luminance of gray level 63 at 5 points  $\cdot$   $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

**Note 6**: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

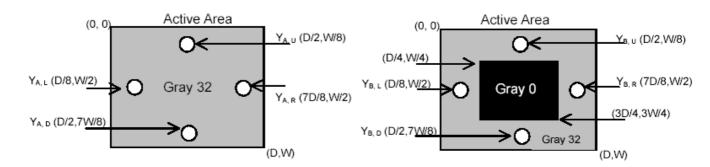
$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

### Where

Y<sub>A</sub> = Luminance of measured location without gray level 0 pattern (cd/m<sub>2</sub>)

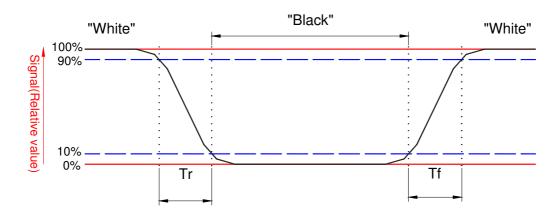
Y<sub>B</sub> = Luminance of measured location with gray level 0 pattern (cd/m<sub>2</sub>)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.





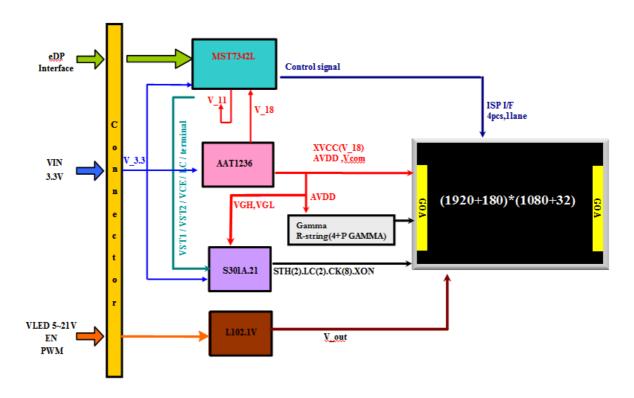
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### Note 9. Definition of viewing angle

Viewing angle is the measurement of contrast ratio  $\geq$  10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° ( $\theta$ ) horizontal left and right and 90° ( $\Phi$ ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.



### 3. Functional Block Diagram



### 4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

### 4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	4	[Volt]	Note 1,2

## 4.2 Absolute Ratings of Touch Sensor Module

Item	Symbol	Min	Max	Unit	Conditions
Touch Sensor Module Power Voltage	VTSP	-0.3	7	[Volt]	
Touch Sensor Module Reset Signal	RST	-0.3	3.6	[Volt]	
Touch Sensor Module enable Signal	TP_EN	-0.3	3.6	[Volt]	



### 4.3 Absolute Ratings of Environment

Item	Symbol	Min	Max	Unit	Conditions
Operating Temperature	TOP	0	+50	[°C]	Note 4
Operation Humidity	HOP	5	95	[%RH]	Note 4
Storage Temperature	TST	-20	+60	[°C]	Note 4
Storage Humidity	HST	5	95	[%RH]	Note 4

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

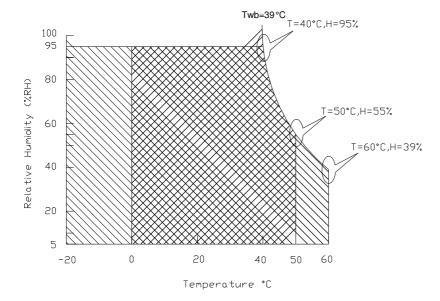
Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).

Note 5: The packing material of system forbid to involve ammonium component

Note 6: The reliability test conditions of system do not exceed the verified conditions of TFT module

Note 7: Be sure the panel test condition do not exceed the component limitation of TFT module(TN Liquid crystal, for example)



### 5. Electrical Characteristics

### **5.1 TFT LCD Module**

### 5.1.1 Power Specification

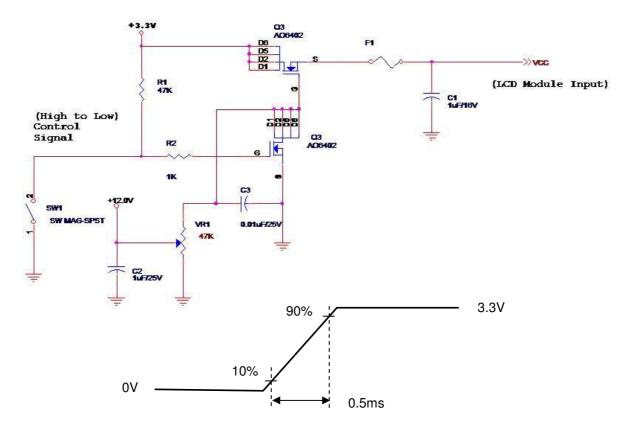
Input power specifications are as follows;

The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	-	-	1.1	[Watt]	Note 1
IDD	IDD Current	-	-	366	[mA]	Note 1
lRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : Mosaic pattern (PDD (max) = VDD(min) x IDD(max))

Note 2: Measure Condition

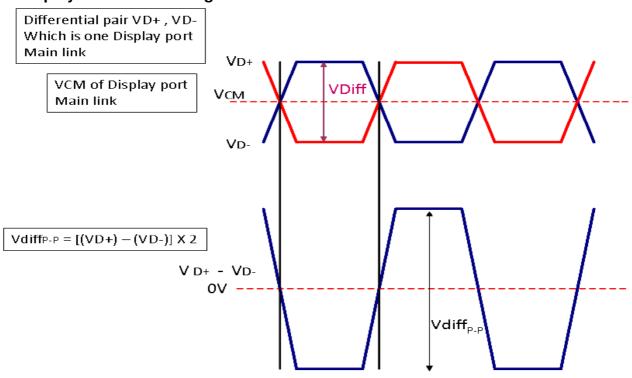


Vin rising time

### **5.1.2 Signal Electrical Characteristics**

Signal electrical characteristics are as follows;

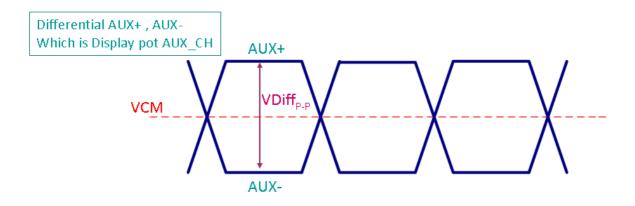
### Display Port main link signal:



	Display port main link									
		Min	Тур	Max	unit					
VCM	CM RX input DC Common Mode Voltage 0 V									
VDiff <sub>P-P</sub>	VDiff <sub>P-P</sub> Peak-to-peak Voltage at a receiving Device 150 1320 mV									

Follow as VESA display port standard V1.3

### **Display Port AUX\_CH signal:**





	Display port AUX_CH								
		Min	Тур	Max	unit				
VCM	AUX DC Common Mode Voltage		0		V				
VDiff <sub>P-P</sub>	AUX Peak-to-peak Voltage at a receiving Device	270		800	mV				

Follow as VESA display port standard V1.3.

### **Display Port VHPD signal:**

	Display port VHPD								
		Min	Тур	Max	unit				
VHPD	HPD Voltage	2.25	1	3.6	٧				

Follow as VESA display port standard V1.3



5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power					[]\/\c\	/To 05°0\ Note 1
Consumption	PLED	-	-	3.2	[Watt]	(Ta=25°C), Note 1
LED Life-Time	N/A	15,000	-	-	Hour	(Ta=25℃), Note 2

Note 1: Calculator value for reference P<sub>LED</sub> = VF (Normal Distribution) \* IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

### 5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED (Note 1)	6.0 (Note 2)	12.0	21.0	[Volt]	
LED Enable Input High Level	VLED EN	2.5	ı	5.5	[Volt]	
LED Enable Input Low Level	VEED_EIN	-	-	0.6	[Volt]	Define as
PWM Logic Input High Level		2.5	-	5.5	[Volt]	Connector Interface
PWM Logic Input Low Level	VPWM_EN	-	ı	0.6	[Volt]	(Ta=25°C)
PWM Input Frequency	FPWM	200	1K	10K	Hz	
PWM Duty Ratio	Duty	1 (Note 3)		100	%	

Note 1: Recommend system pull up/down resistor no bigger than 10kohm

Note 2: measured in panel VIN



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Note 3: If the PWM duty ratio(min) is set between 5% to 1%, the PWM input frequency should be set below 1KHz.

The brightness-duty characteristic might not be able to keep in it's linearity if the dimming control is operated in 1% to 5% range.

### **5.3 Touch Sensor Module**

### 5.3.1 Power Specification

Items	Symbol	Sp	ecification	Unit	Notes		
nome.	- Cymbon		Min.	Тур.	Max.	Orme	140100
Touch sensor module	VTSP		4.5	5	5.5	٧	
Power Supply							
Touch Sensor Module Power ripple	VTSPrp	ı	-	100	mV		
Input Voltage	RST, TP_EN	VIH	2.64		3.3	V	
par renage	VIL		0		0.66	V	
Touch sensor module	$P_{VTSP}$				0.3	W	Active
Power Comsumption	ı VTSP				0.0	,,,	mode



### 6. Signal Interface Characteristic

### 6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

		1									19	20	)
1st Line	R	G	В	R	G	В		R	G	В	R	G	В
							1		1				
		•					•		ı				
							•						
							•		•				
		•			•		•		•			•	
							,						
							1		1				
	Н												
1080th Line	R	G	В	R	G	В		R	G	В	R	G	В



### **6.2 Integration Interface Requirement**

### **6.2.1 Connector Description**

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	I-PEX 20455-040E-76B or Compatible
Mating Housing/Part Number	IPX or compatible

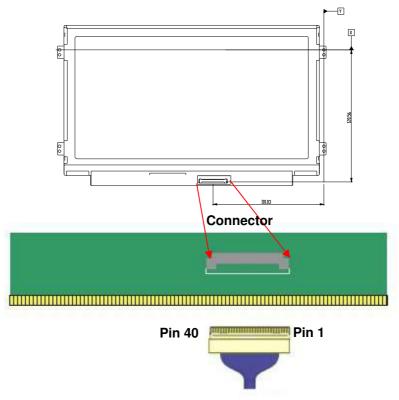
### 6.2.2 Pin Assignment (with Touch Sensor Pin Assignment)

Pin	Symbol	Description
1	DCR	DCR Function
2	GND	High Speed Ground
3	Lane1_N	Complement Signal Link Lane 1
4	Lane1_P	True Signal Link Lane 1
5	GND	High Speed Ground
6	Lane0_N	Complement Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Channel
10	AUX_CH_N	Complement Signal Auxiliary Channel
11	GND	High Speed Ground
12	VCC	LCD logic and driver power
13	VCC	LCD logic and driver power
14	LCD Self Test or NC	LCD Panel Self Test Enable (Optional)
15	GND	LCD logic and driver ground
16	GND	LCD logic and driver ground
17	HPD	HPD signal pin
18	BL_GND	LED Backlight ground
19	BL_GND	LED Backlight ground
20	BL_GND	LED Backlight ground
21	BL_GND	LED Backlight ground
22	BL ENABLE	LED Backlight control on/off control
23	BL PWM	System PWM signal input for dimming
24	NC Reserved	Reserved for LCD manufacture's use
25	NC Reserved	Reserved for LCD manufacture's use



		1
26	VLED	LED Backlight power (12V Typical)
27	VLED	LED Backlight power (12V Typical)
28	VLED	LED Backlight power (12V Typical)
29	VLED	LED Backlight power (12V Typical)
30	NC Reserved	Reserved for LCD manufacture's use
31	DM (USB-)	Touch panel USB D-
32	DP (USB+)	Touch panel USB D+
33	GND	GND
34	Touch Power line	Touch Panel Power line 5V
35	Touch Power line	Touch Panel Power line 5V
36	Touch_EN(Report Switch)	Touch_EN(Report Switch)
37	TP I2C-SCK	Touch panel I2C-SCK
38	TP I2C-SDA	Touch panel I2C-SDA
39	TP I2C-INT	Touch panel I2C-INT
40	TP_RST	Touch paenl IC reset, Low active

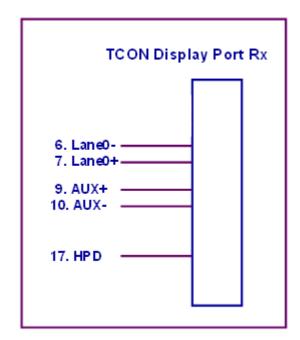




Note1: Start from right side.

Note2: Input signals shall be low or High-impedance state when VDD is off.

Internal circuit of **eDP inputs** are as following.





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### 6.3.1 Timing Characteristics

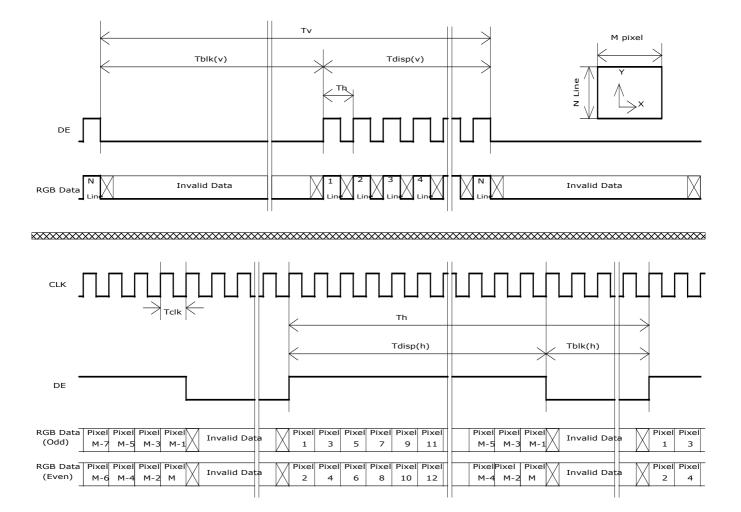
Basically, interface timings should match the 1920x1080 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit
Frame Rate		-		60	-	Hz
Clock fr	Clock frequency		66.6	72	80	MHz
	Period	T <sub>V</sub>	1090	1116	1080+A	
Vertical	Active	T <sub>VD</sub>		1080		
Section	Blanking	<b>T</b> <sub>VB</sub>	10	36	Α	
	Period	T <sub>H</sub>	1000	1052	960+B	
Horizontal	Active	<b>T</b> <sub>HD</sub>		960		$T_{Clock}$
Section	Blanking	<b>T</b> HB	40	92	В	

Note 1: The above is as optimized setting

Note 2: The maximum clock frequency = (1920+B)\*(1080+A)\*60 < 149.1 MHz

### 6.3.2 Timing diagram



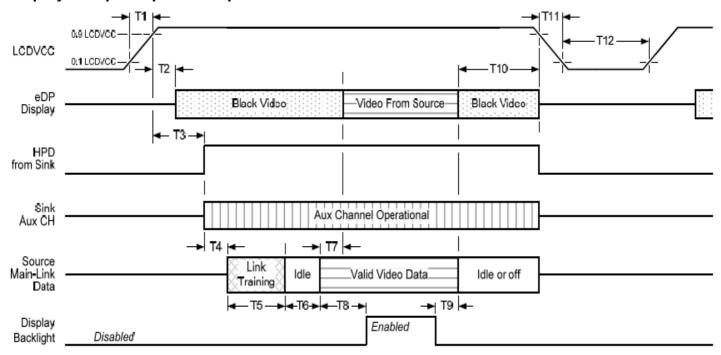


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### 6.4 Power ON/OFF Sequence

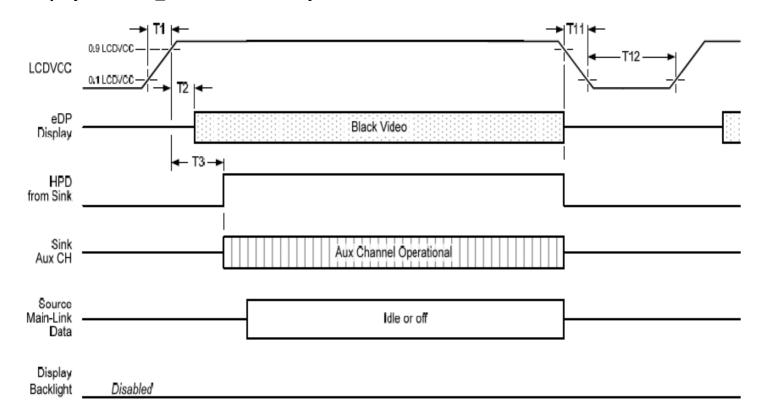
Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off

### **Display Port panel power sequence:**



Display port interface power up/down sequence, normal system operation

### **Display Port AUX CH transaction only:**



Display port interface power up/down sequence, AUX\_CH transaction only



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### Display Port panel power sequence timing parameter:

Timing	Description	Donal Inc	Limits			Natas	
parameter	Description	Reqd. by	Min.	Тур.	Max.	Notes	
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms		
Т2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source	
Т3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.	
Т4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.	
Т5	link training duration	source				dependant on source link to read training protocol.	
Т6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.	
<b>T7</b>	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.	
Т8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.	
Т9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.	
T10	delay from end of valid video data from source to power off	source	0ms		500ms		
T11	power rail fall time, 905 to 10%	source			10ms		
T12	power off time	source	500ms				

**Note1:** The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

-upon LCDVDD power on (with in T2 max)-when the "Novideostream\_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).

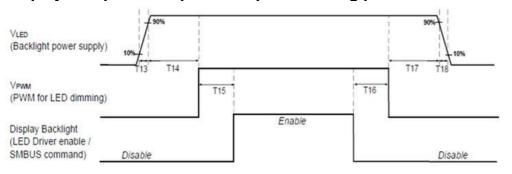
-when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

**Note 2:** The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

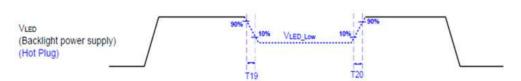
**Note 3:** The sink must support AUX\_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX\_CH transaction with the time specified within T3 max.



### Display Port panel B/L power sequence timing parameter:



Note: When the adapter is hot plugged, the backlight power supply sequence is shown as below.



	Min (ms)	Max (ms)
T13	0.2	10
T14	0	2
T15	0	-
T16	0	-
T17	0	
T18	0.2	10
T19	1*	<u> </u>
T20	1*	<u>2</u>

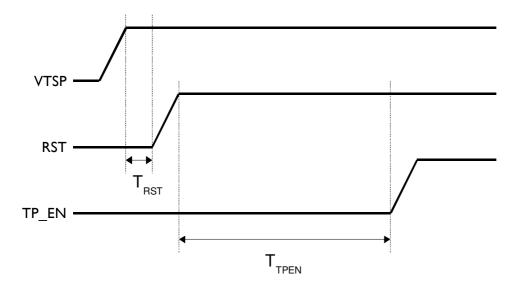
Seamless change: T19/T20 = 5xT<sub>PWM</sub>\*

\*T<sub>PWM</sub>= 1/PWM Frequency

Note 1: If T14,T15,T16,T17<10ms, The display garbage may occur. We suggest T14,T15,T16,T17>10ms to avoid the display garbage.

Note 2: If T13 or T18<0.5ms, the inrush current may cause the damage of fuse. If T13 or T18<0.5ms, the inrush current I<sup>2</sup>t is under typical melt of fuse Spec. , there is no mentioned problem.

### **Touch Panel Power on Sequence**



Timing	Description	Min (ms)
T <sub>RST</sub>	Reset signal delay time from VTSP (TP power)	1
T <sub>TPEN</sub>	TP enable signal delay time from reset signal	20



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### 7. Panel Reliability Test

### 7.1 Vibration Test

**Test Spec:** 

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

### 7.2 Shock Test

**Test Spec:** 

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

### 7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta=0℃, 300h	
High Temperature Storage	Ta= 60℃, 300h	
Low Temperature Storage	Ta= -20℃, 250h	
Thermal Shock Test	Ta=-20°C (30min) ~60°C (30min), 100cycles condition.	
ESD	Contact : ±8 KV Air : ±15 KV	Note 1

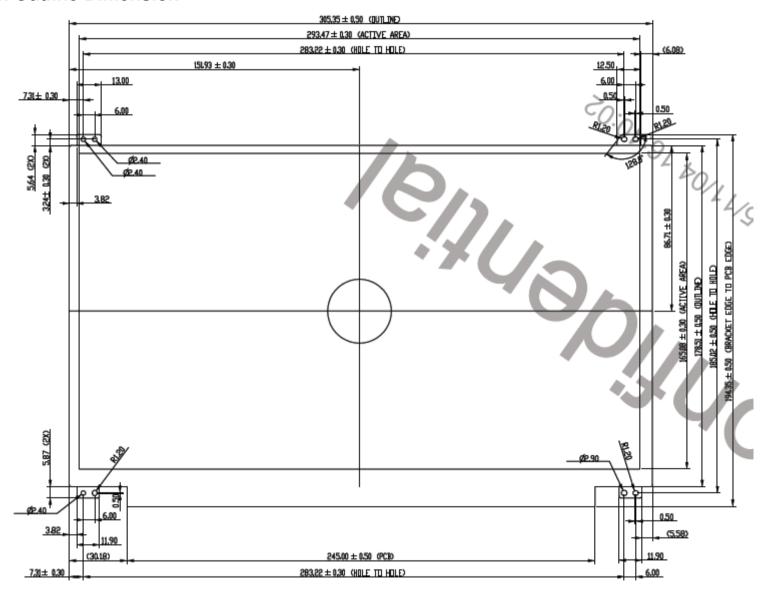
Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

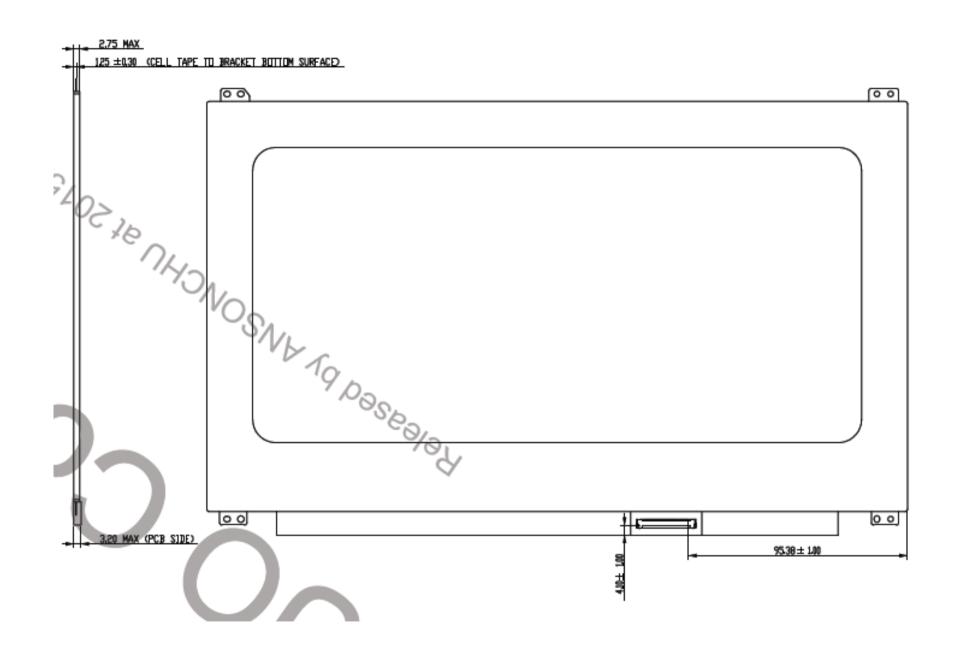
. Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%

### 8. Mechanical Characteristics

### 8.1 Total Solution Outline Dimension





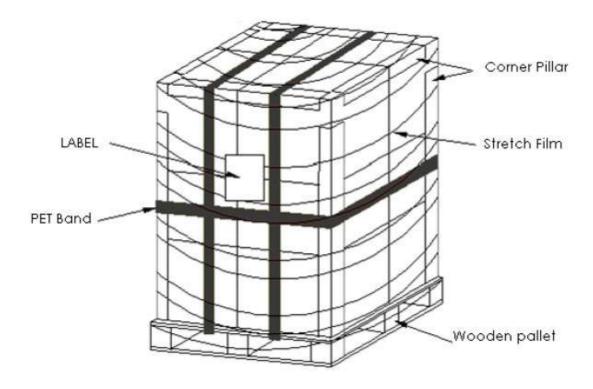
### 9. Shipping and Package

### 9.1 Shipping Label Format





## 9.2 Shipping Package of Palletizing Sequence



### 10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	111111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	2D	00101101	45	
0B	hex, LSB first	10	00010000	16	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	19	00011001	25	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	95	10010101	149	
15	Max H image size (rounded to cm)	1D	00011101	29	
16	Max V image size (rounded to cm)	11	00010001	17	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	C3	11000011	195	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	14	00010100	20	
1B	Red x (Upper 8 bits)	93	10010011	147	
1C	Red y/ highER 8 bits	58	01011000	88	
1D	Green x	59	01011001	89	
1E	Green y	92	10010010	146	
1F	Blue x	29	00101001	41	
20	Blue y	22	00100010	34	
21	White x	51	01010001	81	
22	White y	57	01010111	87	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	00000001	1	
28	Standard timing #2	01	00000001	1	
29		01	00000001	1	
2A	Standard timing #3	01	00000001	1	
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	

2D		01	00000001	1	
2E	Standard timing #5	01	00000001	<u>'</u> 1	
2F	Otandara tiriirig #0	01	00000001	<u>'</u> 1	
30	Standard timing #6	01	00000001	<u>'</u> 1	
31	Otandard timing #0	01	00000001	1	
32	Standard timing #7	01	00000001	1	
33	Standard timing #7	01	00000001	1	
34	Standard timing #8	01	00000001	1	
35	Standard timing #0	01	00000001	1	
36	Pixel Clock/10000 LSB	14	00010100	20	
37	Pixel Clock/10000 USB	37	00110111	55	
38	Horz active Lower 8bits	80	10000000	128	
39	Horz blanking Lower 8bits	B8	101111000	184	
3A	HorzAct:HorzBlnk Upper 4:4 bits	70	01110000	112	
3B	Vertical Active Lower 8bits		00111000		
3C	Vertical Planking Lower 8bits	38 24	00100100	56 36	
3D	Vertical Blanking Lower obits  Vert Act : Vertical Blanking (upper 4:4 bit)	40		36 64	
3D 3E	HorzSync. Offset	10	01000000		
3E 3F	HorzSync.Width			16	
3F 40	VertSync.Offset : VertSync.Width	10 3E	00010000	16 62	
	Horz‖ Sync Offset/Width Upper 2bits				
41	Horizontal Image Size Lower 8bits	00	00000000	0	
42	Vertical Image Size Lower 8bits	25	00100101	37	
43	Horizontal & Vertical Image Size (upper 4:4 bits)	A5	10100101	165	
44	Horizontal Border (zero for internal LCD)	10	00010000	16	
45	Vertical Border (zero for internal LCD)	00	00000000	0	
46		00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56 57		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59	<b>5</b>	20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	

5E		00	00000000	0	
5F	Manufacture	41	01000001	65	Α
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	33	00110011	51	3
74	Manufacture P/N	33	00110011	51	3
75	Manufacture P/N	48	01001000	72	Н
76	Manufacture P/N	41	01000001	65	Α
77	Manufacture P/N	4B	01001011	75	K
78	Manufacture P/N	30	00110000	48	0
79	Manufacture P/N	31	00110001	49	1
7A	Manufacture P/N	2E	00101110	46	
7B	Manufacture P/N	30	00110000	48	0
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	5A	01011010	90	